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PC35A31 V0 Product Specification



Approval Sheet

PC35A31 V0
Product Specification





ellow SMD LED
C35A31 V0
018/12/25



Feature

- ✓ Yellow SMD LED (L x W x H) of 3.5 x 2.8 x 1.9 mm
- ✓ AEC-Q101 Rev. D and IEC 60810 qualification
- ✓ Dice Technology : AlGaInP
- ✓ Qualified according to JEDEC moisture sensitivity Level 2
- ✓ Environmental friendly; RoHS compliance
- ✓ ESD protection
- √ Packing: 2,000 or 1,000 pcs/reel

Applications

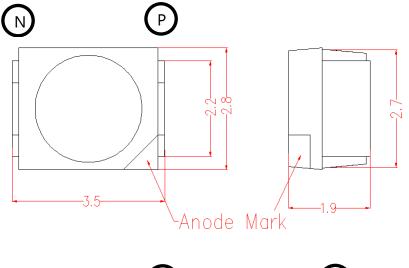
- ✓ Optical Indicator
- ✓ Automotive Interior lighting
- ✓ Backlighting
- ✓ Outdoor displays
- ✓ Signal and symbol Luminary
- ✓ Dash board lighting

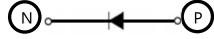


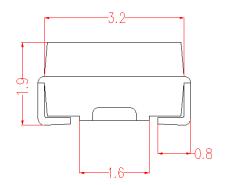
Outline Dimension

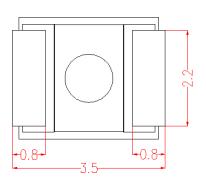
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Package Dimension



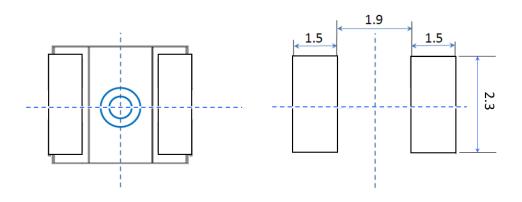






Unit: mm, Tolerance: ±0.1mm

■ Recommended Soldering Pad





Performance

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■ Electro-Optical Characteristics (Ta=25°C)

		,				
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	V_{F}		1.8	2.15	2.4	V
Luminous Flux	lv		650	850	1000	mcd
Dominant Wavelength	nm	$I_F = 20 \text{ mA}$	585.5	590	595	nm
View Angle	θ			120		deg
Thermal Resistance	Rth		240			°C/W

^{*} The Forward Voltage tolerance is ±0.05V

Absolute Maximum Ratings

Parameter	Symbol	value	Unit
DC Forward Current ⁽¹⁾	I _F	30	mA
Power Dissipation	P_{D}	0.04	W
Pulse Forward Current ⁽²⁾	IFP	50	mA
Storage Temperature	T _{stg}	-40 ~ + 105	°C
Operating Temperature	T_{opr}	-40 ~ + 105	°C
Junction Temperature	Tj	125	°C
ESD (HBM)	ESDнвм	2000	V
Assembly Temperature	Tsld	260	°C

⁽¹⁾ Proper current rating must be observed to maintain junction temperature below maximum at all time

(2) IFP Condition: Duty 5/1000, Pulse within 10 us

^{*} The luminous intensity tolerance is ± 8%

^{*} The Wavelength tolerance is ±0.5nm



Binning

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■ Bin code Definition

V _F Rank	Luminous Flux Rank	Wd Rank
Α	V1	A1000

Forward Voltage Definition Group

V _F Rank	Condition	Min. (V)	Max. (V)
Α	1 - 20 m 1	1.80	2.00
В	I _F = 20 mA	2.00	2.20
С	Tj=25℃	2.20	2.40

■ Luminous Intensity Definition Group

Luminous Intensity Rank	Condition	Min. Iv (mcd)	Max. Iv (mcd)
V1		650	750
V2	I = 20 mA	750	800
V3	I _F = 20 mA Tj=25℃	800	850
V4		850	900
V5		900	1000

CIE Rank

Wd Rank	Condition	Min. Wd (nm)	Max. Wd (nm)
A1000	1 - 20 m 1	585.5	588.5
A2000	I _F = 20 mA Ti=25℃	588.5	592.5
A3000	13-25	592.5	595.0

^{*} The Forward Voltage tolerance is ±0.05V

^{*} The luminous intensity tolerance is ± 8%

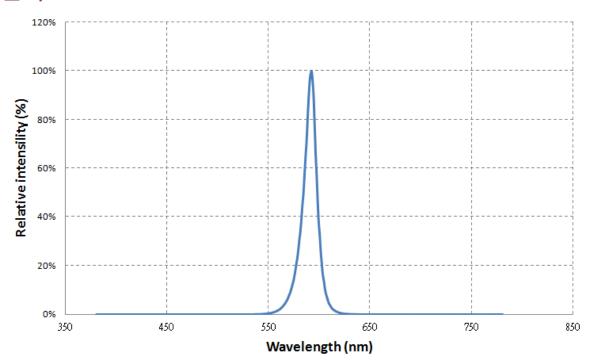
^{*} The Wavelength tolerance is ±0.5nm



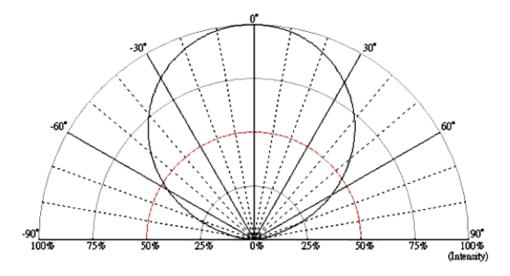
Characteristics

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Spectrum

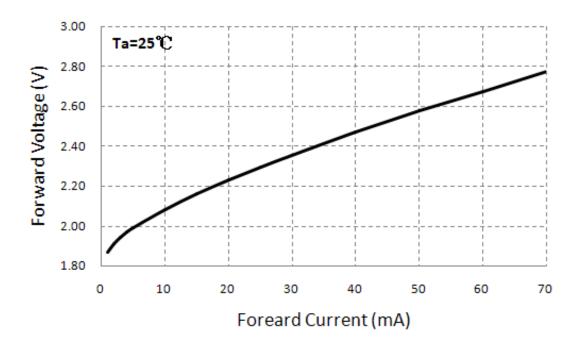


Radiation Pattern

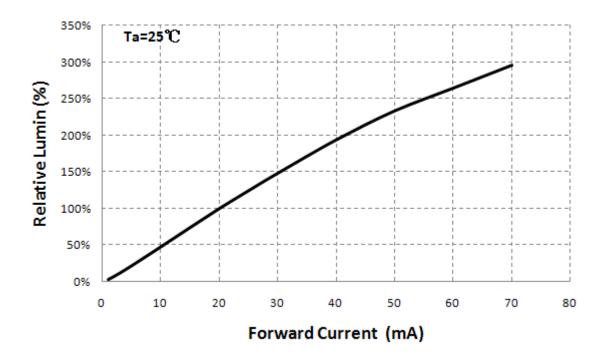




■ Forward Voltage vs. Forward Current, Ta=25°C

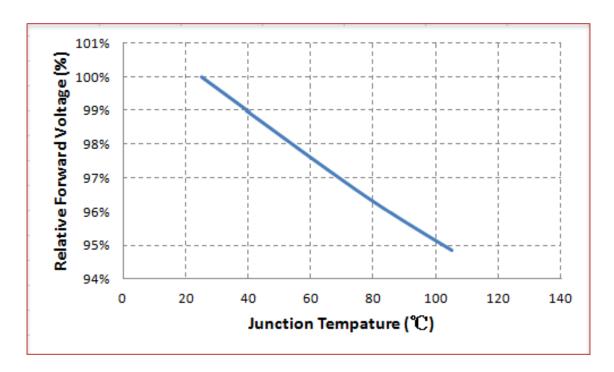


■ Forward Current vs. Relative Luminous Intensity, Ta=25°C

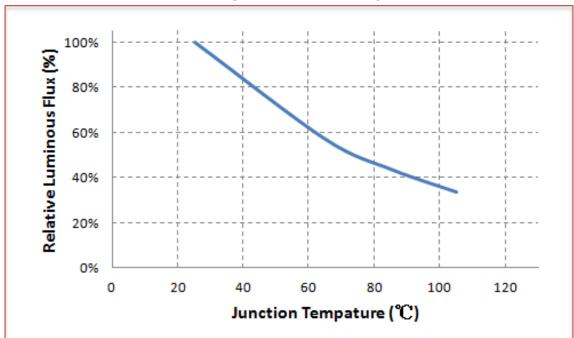




■ Relative Forward Voltage vs. Junction Temperature

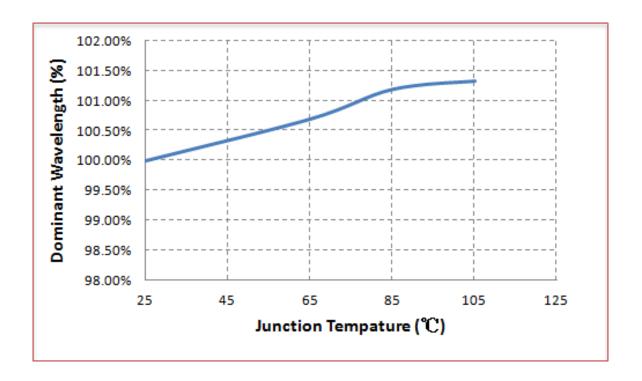


■ Relative Luminous Intensity vs. Junction Temperature

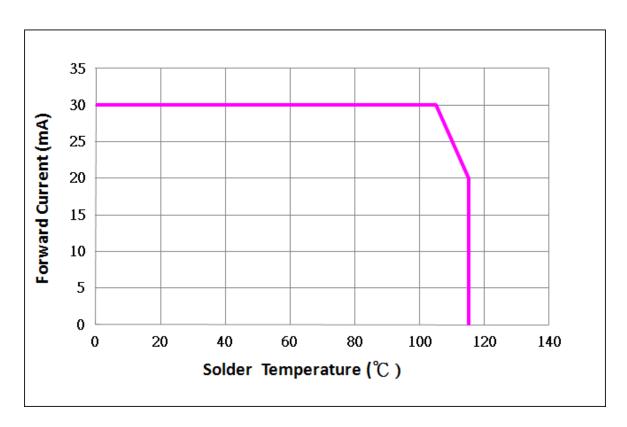




Relative Dominant Wavelength vs. Junction Temperature



Derating Curve





Reliability

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Reliability test

	ltem	Reference Standard	Condition	Time/Cycle
1	Thermal shock	JESD22-A106	-40°C to 100 °C, 20 mins dwell, 5 min transfer time	1000 Cycles
2	Power and Temperature Cycle	AEC-Q101 Rev. D	-40 °C~ 85 °C, IF=30mA, Dwell/transfer time = 10 mins, 20 mins 1,000 cycles , on/off 15,000 cycles	15,000 cycles
3	MSL Level 2	J-STD-020	85°C / 60% RH	168 hours
4	High Temperature Storage	JESD22-A103	TA=105°C, 1000h	1000 hours
5	Low Temperature Storage	JESD22-A119	TA=-40°C, 1000h	1000 hours
6	High Temperature Operating Life	AEC-Q101 Rev. D	TA=105°C, IF=30mA	1000 hours
7	Low Temperature Operating Life	JESD22-A108	TA=-40°C, IF=30mA	1000 hours
8	Temperature Humidity Operating Life	AEC-Q101 Rev. D	85°C, RH=85%, 1000h, IF=30mA	1000 hours
9	Electrostatic Discharges	AEC-Q101 Rev. D	HBM 2 KV, 1.5KΩ, 100pF, 3 pulses, alternately positive or negative	

Judgment Criteria

Item	Symbol	Test Condition	Judgment Criteria
Forward Voltage	Vf	20mA	ΔVf < 10 %
Luminous Flux	lv	20mA	ΔIv < 20 %
Delta CIE	CIE-x ,CIE-y	20mA	∆x,y <0.01



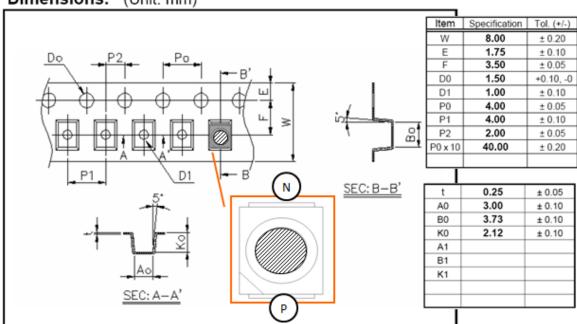
Packing

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Label

Carrier Taping

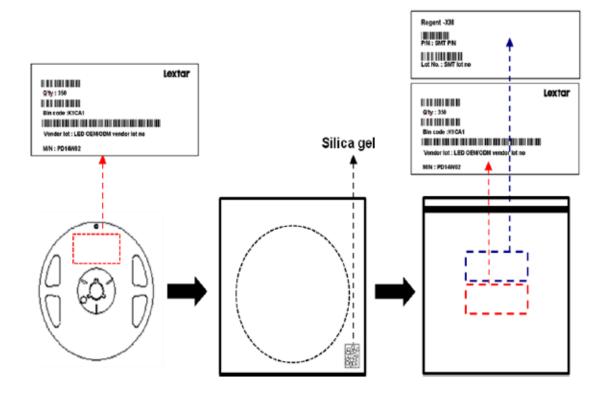
Dimensions. (Unit: mm)





(Unit: mm)

Shield Bag Taping

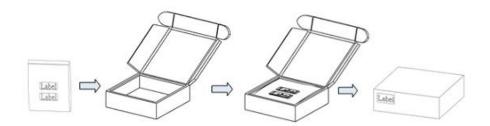


Packing Box

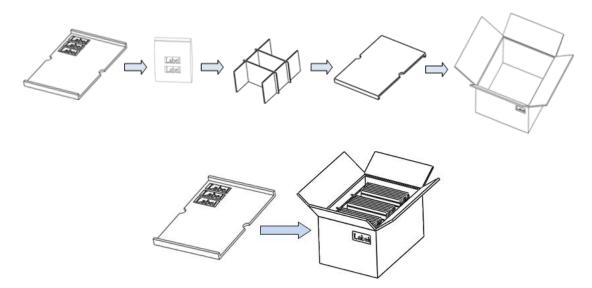
Туре	Large Box		Medium Box		Small Box	
Dimension	541X511X276mm		385X303X260mm		283X235x70m	m
Maximum Reels	7"X12mm Reel	64/R	7"X12mm Reel	21/R	7"X12mm Reel	4/R
Minimum Reels	7"X12mm Reel	32/R	7"X12mm Reel	9/R	7"X12mm Reel	1/R



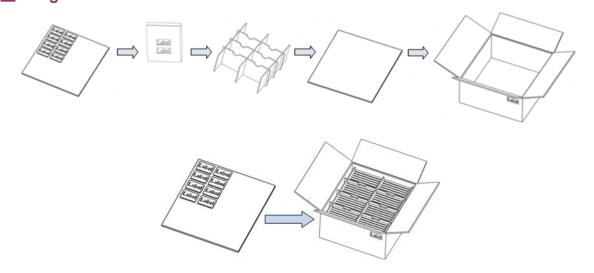
Small Box



■ Medium Box



■ Large Box





Precautions

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Safety Precautions

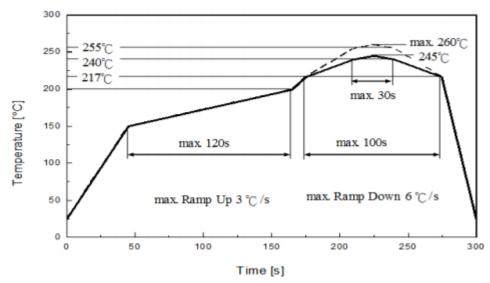
- The LED light output is too strong for human eyes without shield. Prevent eye contact directly more than seconds.
- Ensure operating under maximum rating.

Storage

- Before opening the package, the LEDs should be kept at 40°C, 90% RH environment or less, and should be used within one year.
- After opening the package bag,
 - The LEDs should be kept at 30°C, 60% RH environment or less.
 - The LEDs should be soldered within 12 months (1 year).
 - If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel).
- If the package is over storage time, the LEDs should be pre-bake 65 \pm 5 °C / 12 hrs before use. (One time only).

■Soldering Notice and Conditions

- When soldering LEDs,
- Do not solder/reflow the same LED over two times.
- Reflow temperature profile as below: (lead-free solder)



Classification Reflow Profile (JEDEC J-STD-020D)



- When soldering, don't put stress on the LEDs
- After LEDs have been soldered, strongly recommend not to repair to keep the LEDs performance.

Static Electricity

- LED package is extremely sensitive to static electricity. It's recommended that
 anti-electrostatic glove and wrist band is necessary when handling the LEDs. All devices
 are also be grounded properly as well.
- Protection devices design should be considered in the LED driving circuit.

Cleaning

- If washing is required, recommend to use alcohol as a solvent.
- Recommend to avoid cleaning the LEDs by ultrasonic. If necessary, pre-test the LED is necessary to confirm whether any damage occur after the process.



Revision History

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Date	Contents	Writer	Approved
2017.07.04	NEW VERSION	Rudess	Bemore
2017.08.07	Update Reliability test – P.9 Soldering Notice and Conditions – P.13	Rudess	Bemore
2018.03.11	Update Outline Dimension – P.4	Rudess	Bemore
2018.05.28	Update Carrier Taping – P.10	Rudess	Bemore
2018.07.27	Update O.E. data – P.8~9	Rudess	Bemore
2018.10.08	Add De-rating curve – P.10	Rudess	Bemore
2018.12.25	Final version	Rudess	Bemore

Smart Lighting Amazing Life

Lextar Electronics Corp. is the leading LED (Light Emitting Diode)

maker integrating upper stream epitaxial, middle stream chip, and downstream package,

SMT and LED lighting applications. Founded in May, 2008, Lextar is a subsidiary of AU Optronics,

the leading TFT-LCD and solar PV manufacturer. Lextar's product applications include lighting and LCD backlight.

Lextar's manufacturing sites include Hsinchu and Chunan in Taiwan, and Suzhou in China.

The company turnover in 2010 is 266 million USD.